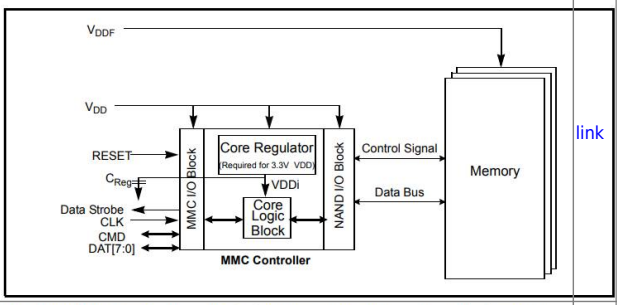
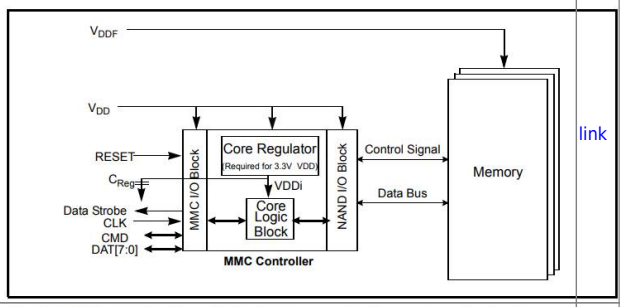
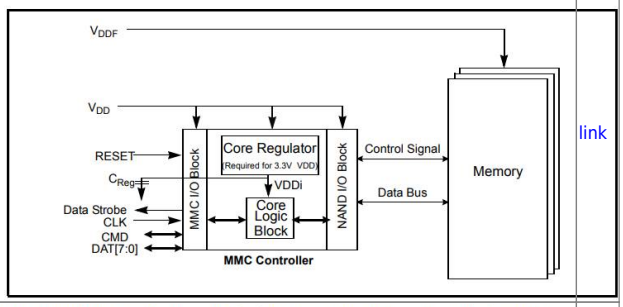
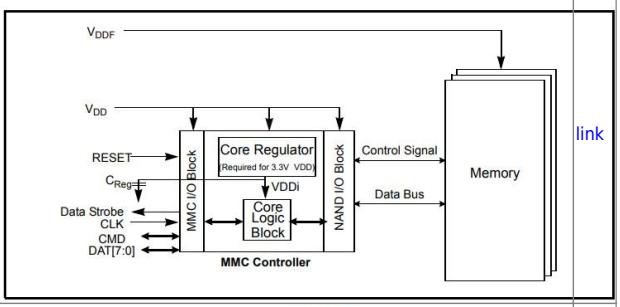
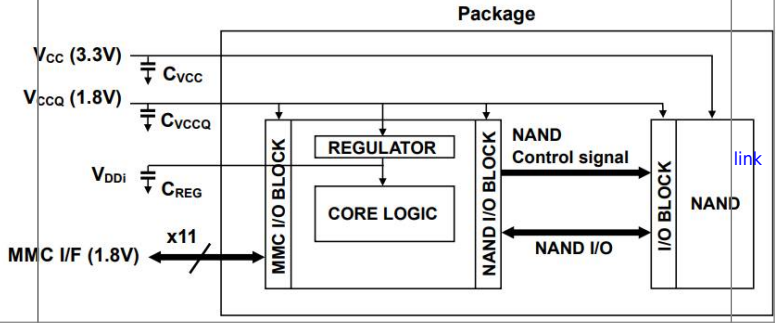
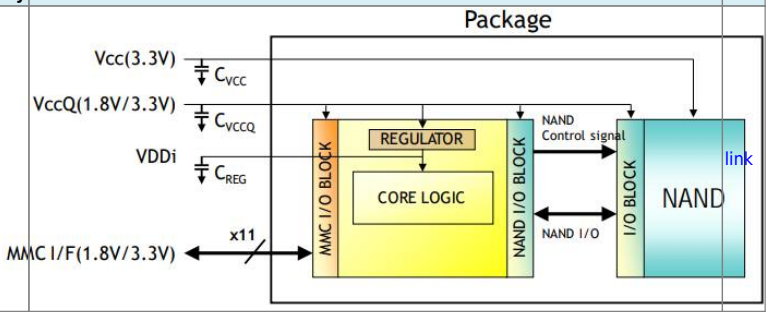
Содержание

eMMC 3
Manufacturers 3

eMMC

Manufacturers

P\N	MFG	Dens	CASE	Interface	Memory	Struct	Link
KLM8G1GETF-B041	SAMSUNG	8GB	153FBGA	VDD (1.70V ~ 1.95V or 2.7V ~ 3.6V)	VDD (2.7 3.6V	- eMMC consists of NAND Flash and Controller. V_{DD} (V_{CCQ}) is for Controller power and V_{DDF} (V_{CC})is for flash power 	link
KLMAG1JETD-B041	SAMSUNG	16GB	153FBGA	VDD (1.70V ~ 1.95V or 2.7V ~ 3.6V)	VDD (2.7 3.6V	- eMMC consists of NAND Flash and Controller. V_{DD} (V_{CCQ}) is for Controller power and V_{DDF} (V_{CC})is for flash power 	link
KLMBG2JETD-B041	SAMSUNG	32GB	153FBGA	VDD (1.70V ~ 1.95V or 2.7V ~ 3.6V)	VDD (2.7 3.6V	- eMMC consists of NAND Flash and Controller. V_{DD} (V_{CCQ}) is for Controller power and V_{DDF} (V_{CC})is for flash power 	link
KLMCG4JETD-B041	SAMSUNG	64GB	153FBGA	VDD (1.70V ~ 1.95V or 2.7V ~ 3.6V)	VDD (2.7 3.6V	- eMMC consists of NAND Flash and Controller. V_{DD} (V_{CCQ}) is for Controller power and V_{DDF} (V_{CC})is for flash power 	link
THGAMRG7T13BAIL	KIOXIA	16GB	153FBGA	**VCCQ = 1.7V to 1.95V**	VCC 2.7V 3.6V	Package 	link

P\N	MFG	Dens	CASE	Interface	Memory	Struct	Link
THGBMNG5D1LBAIL	KIOXIA	4GB	153FBGA	VCCQ = 1.7V to 1.95V / 2.7V to 3.6V	VCC 2.7\ 3.6\		link